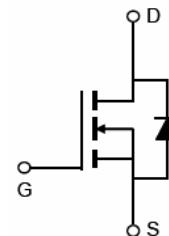


## N-Channel Super Trench Power MOSFET

### Description

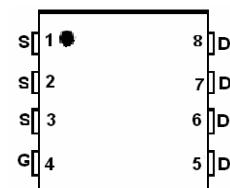
The HMS85N15GA uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of  $R_{DS(ON)}$  and  $Q_g$ . This device is ideal for high-frequency switching and synchronous rectification.



Schematic diagram

### General Features

- $V_{DS} = 150V, I_D = 85A$
- $R_{DS(ON)} = 9.2m\Omega$  (typical) @  $V_{GS} = 10V$
- Excellent gate charge  $\times R_{DS(on)}$  product(FOM)
- Very low on-resistance  $R_{DS(on)}$
- 175 °C operating temperature
- Pb-free lead plating
- 100% UIS tested



Marking and pin assignment

### Application

- LED backlighting
- Ideal for high-frequency switching and synchronous rectification

**100% UIS TESTED!**

### Package Marking and Ordering Information

| Device Marking | Device     | Device Package | Reel Size | Tape width | Quantity   |
|----------------|------------|----------------|-----------|------------|------------|
| HMS85N15GA     | HMS85N15GA | DFN5X6-8L      | Ø330mm    | 12mm       | 2500 units |

### Absolute Maximum Ratings ( $T_A = 25^\circ C$ unless otherwise noted)

| Parameter  | Symbol              | Limit      | Unit |
|--|---------------------|------------|------|
| Drain-Source Voltage                             | $V_{DS}$            | 150        | V    |
| Gate-Source Voltage                              | $V_{GS}$            | $\pm 20$   | V    |
| Drain Current-Continuous                         | $I_D$               | 85         | A    |
| Drain Current-Continuous( $T_C = 100^\circ C$ )  | $I_D (100^\circ C)$ | 59.5       | A    |
| Pulsed Drain Current                             | $I_{DM}$            | 255        | A    |
| Maximum Power Dissipation                        | $P_D$               | 130        | W    |
| Derating factor                                  |                     | 0.87       | W/°C |
| Single pulse avalanche energy (Note 5)           | $E_{AS}$            | 200        | mJ   |
| Operating Junction and Storage Temperature Range | $T_J, T_{STG}$      | -55 To 175 | °C   |

### Thermal Characteristic

|  |                 |      |      |
|--|-----------------|------|------|
| Thermal Résistance, Junction-to-Case <sup>(Note 2)</sup> | $R_{\theta JC}$ | 1.15 | °C/W |
|--|-----------------|------|------|

**Electrical Characteristics ( $T_A=25^\circ\text{C}$  unless otherwise noted)**

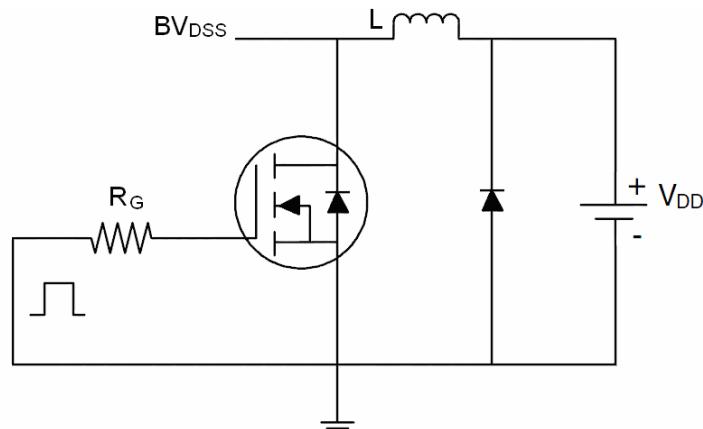
| Parameter                                 | Symbol                     | Condition  | Min | Typ  | Max       | Unit             |
|---|----------------------------|--|-----|------|-----------|------------------|
| <b>Off Characteristics</b>                |                            |  |     |      |           |                  |
| Drain-Source Breakdown Voltage            | $\text{BV}_{\text{DSS}}$   | $V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$   | 150 | -    | -         | V                |
| Zero Gate Voltage Drain Current           | $I_{\text{DSS}}$           | $V_{\text{DS}}=150\text{V}, V_{\text{GS}}=0\text{V}$   | -   | -    | 1         | $\mu\text{A}$    |
| Gate-Body Leakage Current                 | $I_{\text{GSS}}$           | $V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$  | -   | -    | $\pm 100$ | nA               |
| <b>On Characteristics</b> (Note 3)        |                            |  |     |      |           |                  |
| Gate Threshold Voltage                    | $V_{\text{GS}(\text{th})}$ | $V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$   | 1.0 | 2.0  | 3.0       | V                |
| Drain-Source On-State Resistance          | $R_{\text{DS}(\text{ON})}$ | $V_{\text{GS}}=10\text{V}, I_{\text{D}}=20\text{A}$  | -   | 9.2  | 11        | $\text{m}\Omega$ |
| Drain-Source On-State Resistance          | $R_{\text{DS}(\text{ON})}$ | $V_{\text{GS}}=14.5\text{V}, I_{\text{D}}=10\text{A}$  | -   | 11   | 16        | $\text{m}\Omega$ |
| Gate resistance                           | $R_{\text{G}}$             |  | -   | 6.2  | -         | $\Omega$         |
| Forward Transconductance                  | $g_{\text{FS}}$            | $V_{\text{DS}}=5\text{V}, I_{\text{D}}=20\text{A}$   | 15  | -    | -         | S                |
| <b>Dynamic Characteristics</b> (Note 4)   |                            |  |     |      |           |                  |
| Input Capacitance                         | $C_{\text{iss}}$           | $V_{\text{DS}}=75\text{V}, V_{\text{GS}}=0\text{V}, F=1.0\text{MHz}$   | -   | 1300 |           | PF               |
| Output Capacitance                        | $C_{\text{oss}}$           |  | -   | 162  |           | PF               |
| Reverse Transfer Capacitance              | $C_{\text{rss}}$           |  | -   | 11.7 |           | PF               |
| <b>Switching Characteristics</b> (Note 4) |                            |  |     |      |           |                  |
| Turn-on Delay Time                        | $t_{\text{d}(\text{on})}$  | $V_{\text{DD}}=75\text{V}, R_{\text{L}}=7.5\Omega, V_{\text{GS}}=10\text{V}, R_{\text{G}}=3\Omega$           | -   | 10   | -         | nS               |
| Turn-on Rise Time                         | $t_{\text{r}}$             |  | -   | 6.5  | -         | nS               |
| Turn-Off Delay Time                       | $t_{\text{d}(\text{off})}$ |  | -   | 16   | -         | nS               |
| Turn-Off Fall Time                        | $t_{\text{f}}$             |  | -   | 7    | -         | nS               |
| Total Gate Charge                         | $Q_{\text{g}}$             | $V_{\text{DS}}=75\text{V}, I_{\text{D}}=20\text{A}, V_{\text{GS}}=10\text{V}$                                | -   | 21.1 | -         | nC               |
| Gate-Source Charge                        | $Q_{\text{gs}}$            |  | -   | 8    | -         | nC               |
| Gate-Drain Charge                         | $Q_{\text{gd}}$            |  | -   | 4.6  | -         | nC               |
| <b>Drain-Source Diode Characteristics</b> |                            |  |     |      |           |                  |
| Diode Forward Voltage (Note 3)            | $V_{\text{SD}}$            | $V_{\text{GS}}=0\text{V}, I_{\text{S}}=20\text{A}$   | -   | -    | 1.2       | V                |
| Diode Forward Current (Note 2)            | $I_{\text{S}}$             |  | -   | -    | 10        | A                |
| Reverse Recovery Time                     | $t_{\text{rr}}$            | $T_{\text{J}} = 25^\circ\text{C}, I_{\text{F}} = I_{\text{S}}$<br>$dI/dt = 100\text{A}/\mu\text{s}$ (Note 3) | -   | 30   | -         | nS               |
| Reverse Recovery Charge                   | $Q_{\text{rr}}$            |  | -   | 135  | -         | nC               |

**Notes:**

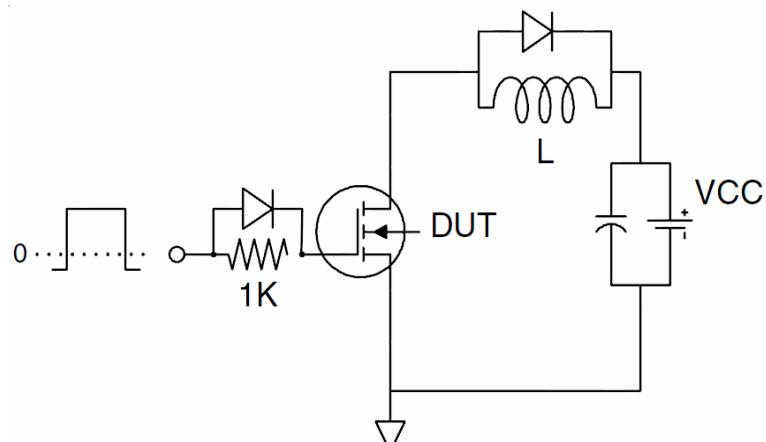
1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board,  $t \leq 10$  sec.
3. Pulse Test: Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$ .
4. Guaranteed by design, not subject to production
5. EAS condition :  $T_j=25^\circ\text{C}, V_{\text{DD}}=75\text{V}, V_{\text{G}}=10\text{V}, L=0.5\text{mH}, R_g=25\Omega$

### Test Circuit

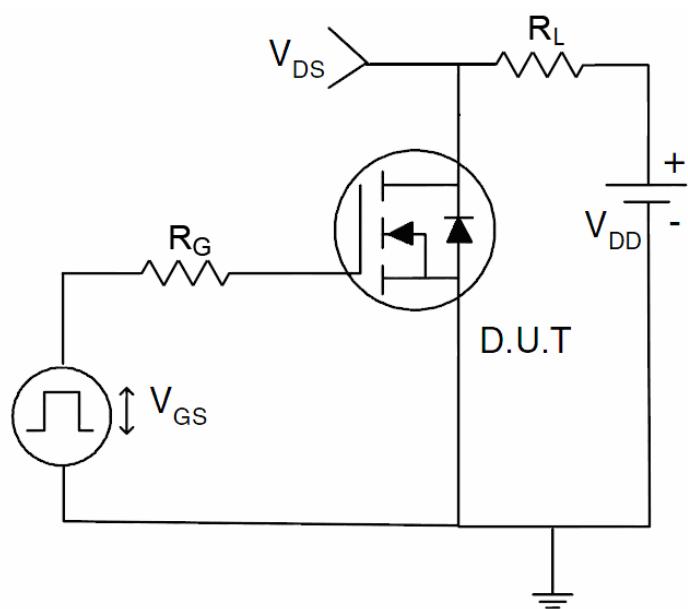
#### 1) E<sub>AS</sub> test Circuit



#### 2) Gate charge test Circuit



#### 3) Switch Time Test Circuit



### Typical Electrical and Thermal Characteristics

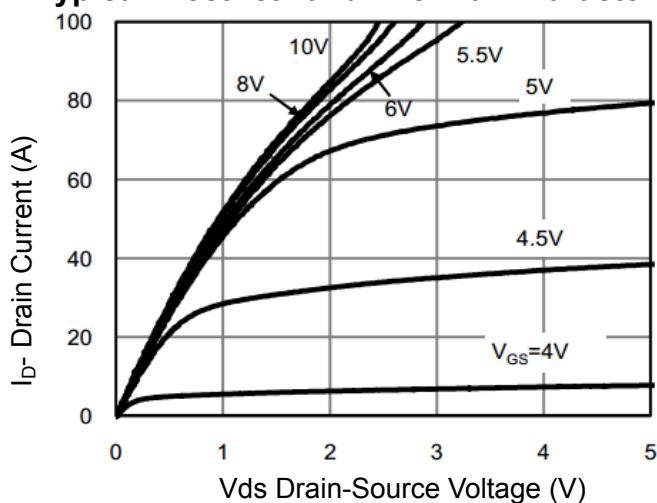


Figure 1 Output Characteristics

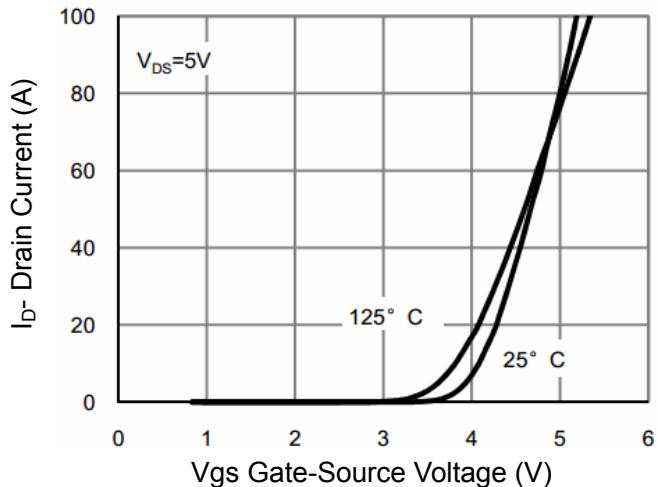


Figure 2 Transfer Characteristics

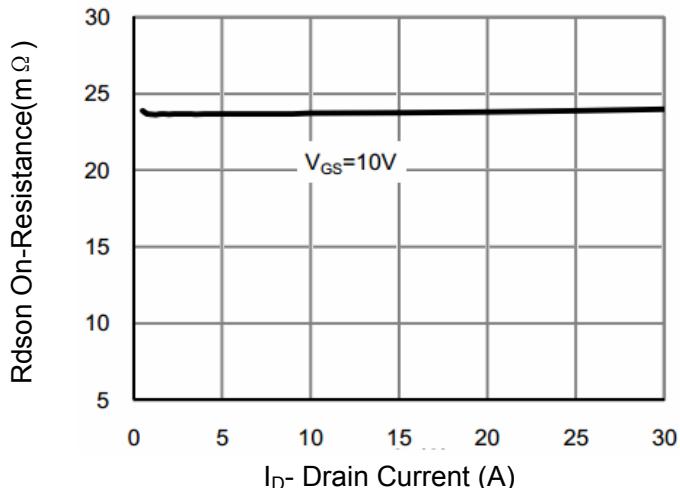


Figure 3 Rdson- Drain Current

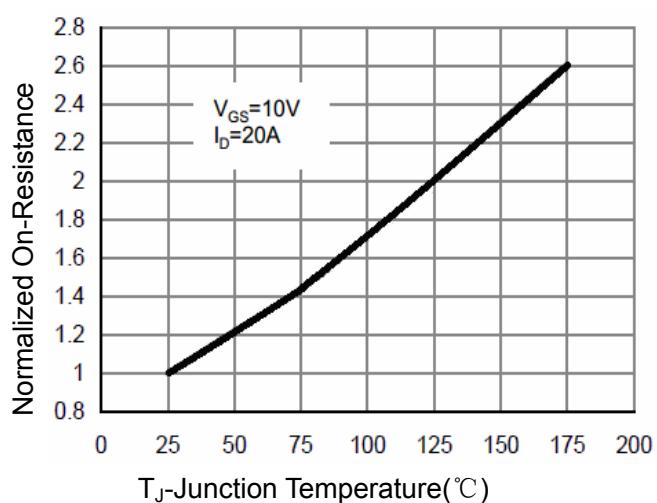


Figure 4 Rdson-Junction Temperature

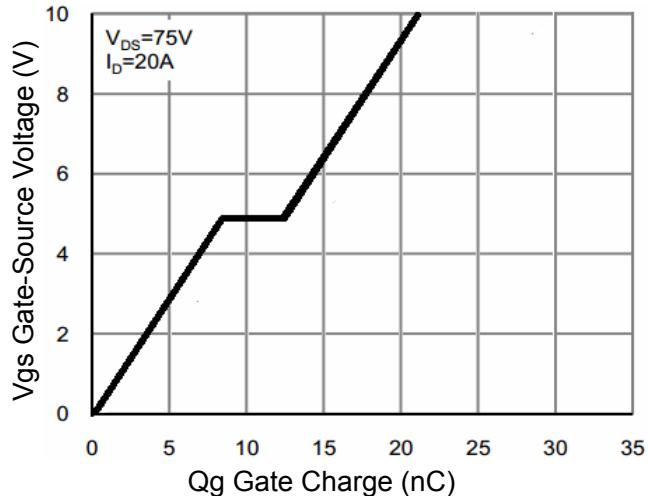


Figure 5 Gate Charge

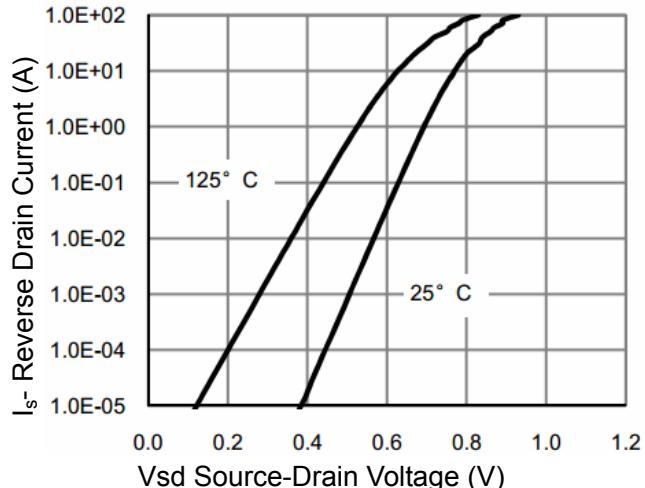


Figure 6 Source- Drain Diode Forward

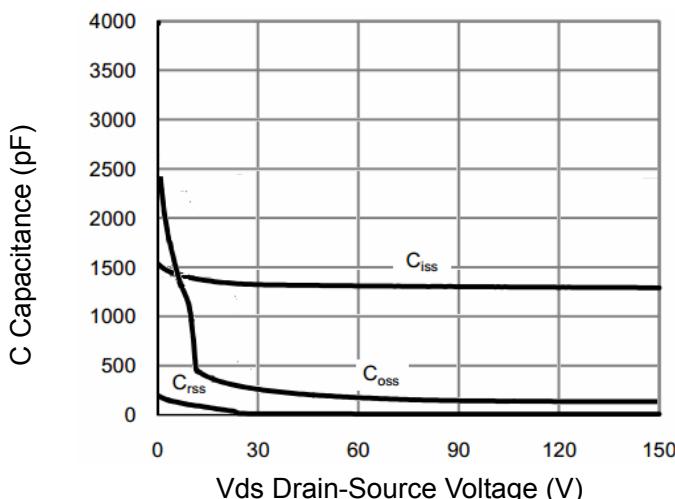


Figure 7 Capacitance vs Vds

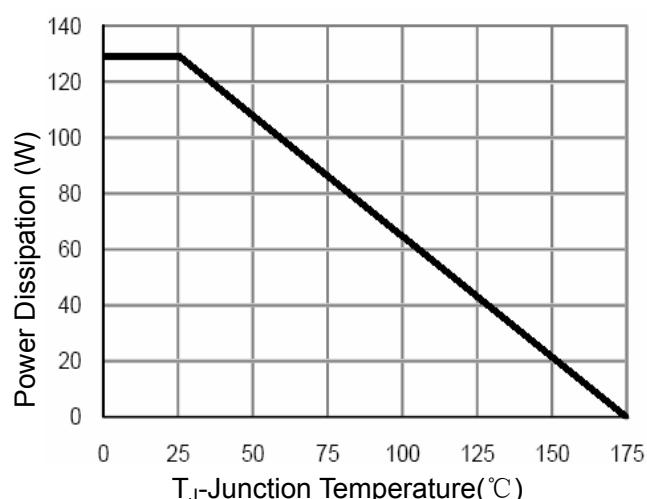


Figure 9 Power De-rating

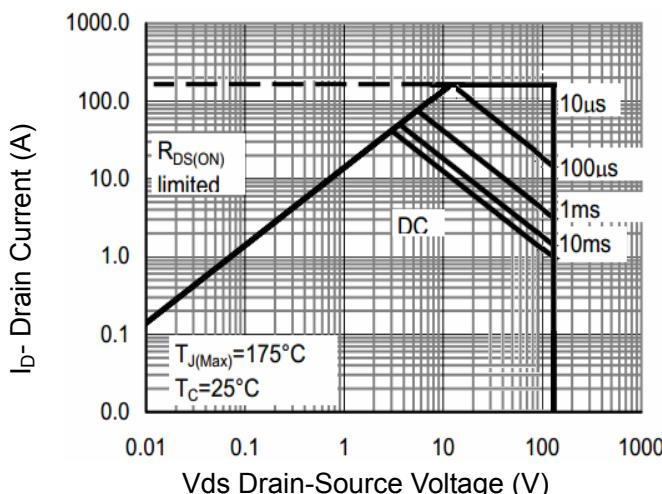


Figure 8 Safe Operation Area

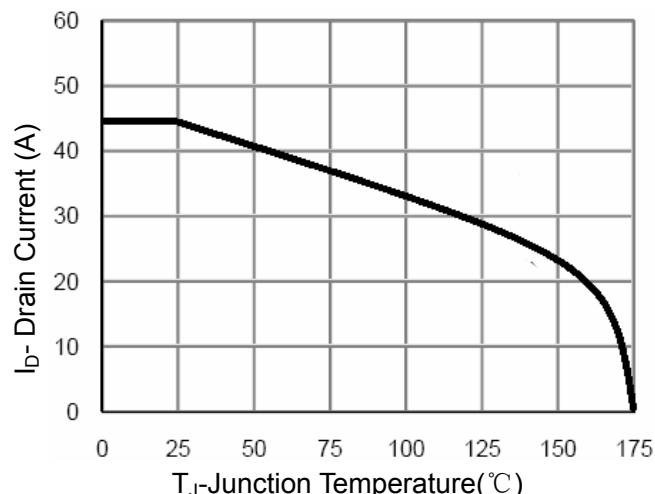


Figure 10 Current De-rating

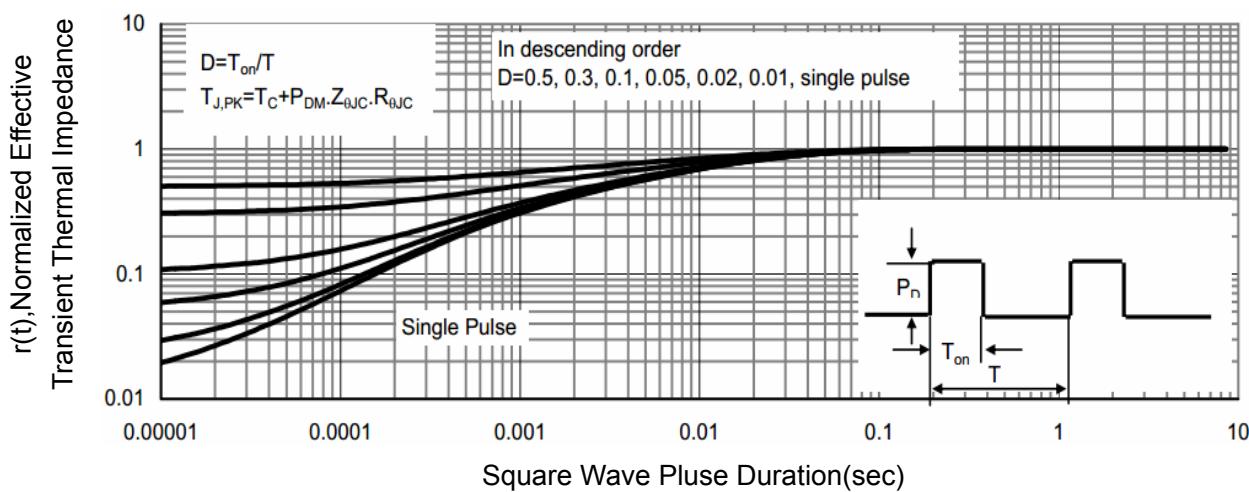
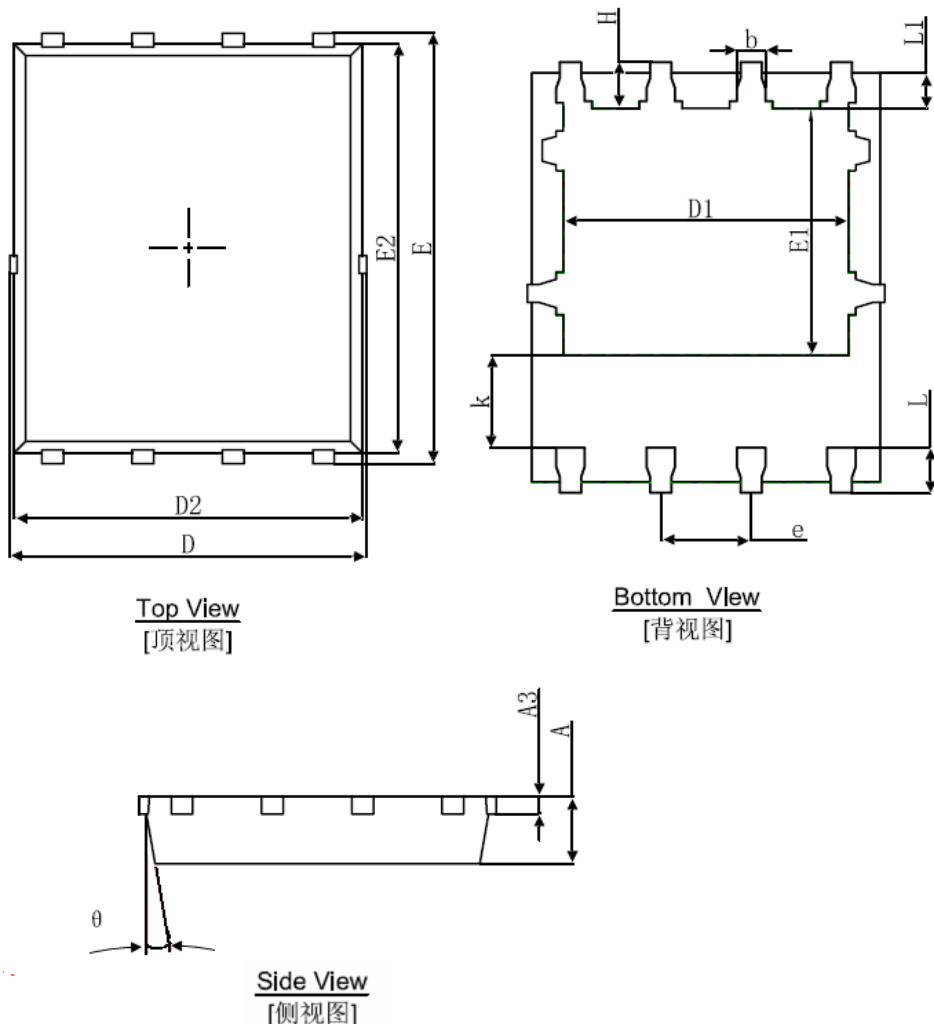


Figure 11 Normalized Maximum Transient Thermal Impedance

DFN5X6-8L Package Information



| Symbol | Dimensions In Millimeters |       | Dimensions In Inches |       |
|--------|---------------------------|-------|----------------------|-------|
|        | Min.                      | Max.  | Min.                 | Max.  |
| A      | 0.900                     | 1.000 | 0.035                | 0.039 |
| A3     | 0.254REF.                 |       | 0.010REF.            |       |
| D      | 4.944                     | 5.096 | 0.195                | 0.201 |
| E      | 5.974                     | 6.126 | 0.235                | 0.241 |
| D1     | 3.910                     | 4.110 | 0.154                | 0.162 |
| E1     | 3.375                     | 3.575 | 0.133                | 0.141 |
| D2     | 4.824                     | 4.976 | 0.190                | 0.196 |
| E2     | 5.674                     | 5.826 | 0.223                | 0.229 |
| k      | 1.190                     | 1.390 | 0.047                | 0.055 |
| b      | 0.350                     | 0.450 | 0.014                | 0.018 |
| e      | 1.270TYP.                 |       | 0.050TYP.            |       |
| L      | 0.559                     | 0.711 | 0.022                | 0.028 |
| L1     | 0.424                     | 0.576 | 0.017                | 0.023 |
| H      | 0.574                     | 0.726 | 0.023                | 0.029 |
| θ      | 8°                        |       | 8°                   |       |